507583146 11/06/2022

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

nic Version v1.1 EPAS ID: PAT7630035

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
HYUNJUNG PARK	12/17/2010
JIWEON JEONG	12/17/2010

RECEIVING PARTY DATA

Name:	LG ELECTRONICS INC.
Street Address:	20, YEOUIDO-DONG, YEONGDEUNGPO-GU
City:	SEOL
State/Country:	KOREA, REPUBLIC OF
Postal Code:	150-721

PROPERTY NUMBERS Total: 1

Property Type	erty Type Number	
Patent Number:	10651331	

CORRESPONDENCE DATA

Fax Number: (703)770-7901

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: (703) 770-7900

Email: docket ip@pillsburylaw.com, chad.hammerlind@pillsburylaw.com,

amanda.childs@pillsburylaw.com, nicole.banks@pillsburylaw.com

Correspondent Name: PILLSBURY WINTHROP SHAW PITTMAN LLP

Address Line 1: P.O. BOX 10500

Address Line 2: ATTN. DOCKETING DEPT.

Address Line 4: MCLEAN, VIRGINIA 22102

ATTORNEY DOCKET NUMBER:	066061-0571538
NAME OF SUBMITTER:	NICOLE BANKS
SIGNATURE:	/Nicole Banks/
DATE SIGNED:	11/06/2022
	This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 2

source=066061-0571538 Parent Assignment filed 06NOV2022#page2.tif source=066061-0571538 Parent Assignment filed 06NOV2022#page3.tif

PATENT 507583146 REEL: 061668 FRAME: 0018

BIRCH, STEWART, KOLASCH & BIRCH, LLP

UNITED STATES PATENT RIGHTS, OR UNITED STATES PLUS ALL FOREIGN PATENT RIGHTS

ASSIGNMENT

Application N	I.o.	12/969,062	Eilad	December 15, 2010		
Application N		12/909,002	Filed	December 15, 2010		
Insert Name(s) of Inventor(s)		***(Given Name FAMILY NAME (ALL CAPS))***				
(-)	WHEREAS, Hyunjung PARK, Jiweon JEONG (hereinafter designated as the undersigned) has (have) invented certain new and useful improvements in:					
Insert Title of Invention	SOLAR CELL MODULE USING SEMICONDUCTOR NANOCRYSTALS					
		n application for Letter (except in the case of a		d States of America has been executed by the		
Insert Date of Signing of	OnDe	cember 17, 2010		; and		
Application Insert Name of Assignee	WHEREAS,	LG ELECTRONICS	INC.			
Insert Address of Assignee	of 20 Yeoui	do-Dong Yeongdeung	po-gu Seoul 150-721	Republic of Korea		
S	of acquiring		nd interest in and to sai	einafter designated as the Assignee) is desirous id invention and in and to any Letters Patent(s) ca and		
CHECK BOX IF APPROPRIATE		oreign countries.				
	NOW THE	DEEODE for good and	realizable consideration	the receipt of which is bereby columnyled and		

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned has (have) sold, assigned and transferred, and by these presents does sell, assign and transfer unto said Assignee the full and exclusive right to the said invention in the United States of America, its territories, dependencies and possessions and the entire right, title and interest in and to any and all Letters Patent(s) which may be granted therefor in the United States of America, its territories, dependencies and possessions, and if the box above is designated, in any and all foreign countries; and to any and all divisions, reissues, continuations, conversions and extensions thereof for the full term or terms for which the same may be granted.

PATENT REEL: 061668 FRAME: 0019 The undersigned agree(s) to execute all papers necessary in connection with this application and any continuing, divisional, conversion or reissue applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation, division, conversion or reissue thereof or Letter Patent(s) or reissue patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to execute all papers and documents and to perform any act which may be necessary in connection with claims or provisions of the International Convention for the Protection of Industrial Property or similar agreements.

The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States of America patent(s) or a grant of a valid United States of America and any foreign patent(s) to the Assignee and to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby authorize(s) and request(s) the Patent and Trademark Office Officials in the United States of America and in any foreign countries to issue any and all Letters Patents resulting from said application or any continuing, divisional conversion or reissue applications thereof to the said Assignee, as Assignee of the entire interest, and hereby covenants that he has (they have) the full right to convey the entire interest herein assigned, and that he has (they have) not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of Birch, Stewart, Kolasch & Birch, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

The undersigned hereby covenant(s) that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

In witness whereof, executed by the undersigned on the date(s) opposite the undersigned name(s).

Date <u>Dec 17.</u> 2010 .	Name of Inventor	(signature) Hyunjung PARK
Date <u>126, 17, 2010</u> ,	Name of Inventor	(signature) Jiweon JEONG
Date,	Name of Inventor	(signature)
Date	Name of Inventor	(signature)
Date	Name of Inventor	(signature)
Date	Name of Inventor	(signature)

Page 2 of 2

BIRCH, STEWART, KOLASCHIN BIRCH, LLP

EHC/SSK6sh